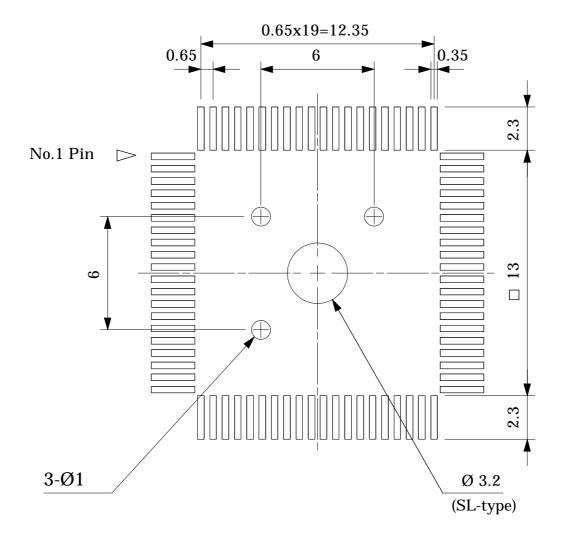


Recommended a Footprint pattern of NQPACK080SB



* Recommended foot pattern shown on left is for NQPACK soldering. But please refer to IC package foot pattern recommended by IC manufacturer also, when the package is soldered on the same foot pattern.

| Part No. | NQPACK080SB | |
|-------------------------|-------------|-------------|
| IC package | Square | |
| Pin count | 80Pin | |
| Lead pitch | 0.65mm | |
| Unit : mm | | Design: M.H |
| TET TOKYO ELETECH CORP. | | |